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INTERNATIONAL STANDARD

NORME INTERNATIONALE

Mechanical structures for electronic equipment. Dimensions of mechanical structures of the 482,6 mm (19 in) series – Part 3-105: Dimensions and design aspects for 10 high chassis

Structures mécaniques pour équipements électroniques – Dimensions des structures mécaniques de la série 482,6 mm (19 pouces) – Partie 3-105: Dimensions et aspects de conception pour les châssis d'une hauteur de 1U





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INTERNATIONAL ELECTROTECHNICAL COMMISSION

MECHANICAL STRUCTURES FOR ELECTRONIC EQUIPMENT – DIMENSIONS OF MECHANICAL STRUCTURES OF THE 482,6 mm (19 in) SERIES –

Part 3-105: Dimensions and design aspects for 1U high chassis

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The text of this standard is based on the following documents:

FDIS	Report on voting
48D/381/FDIS	48D/387/RVD

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all parts of IEC 60297 series, published under the general title *Mechanical structures* for electronic equipment – Dimensions of mechanical structures of the 482,6 mm (19 in) series, can be found on the IEC website.

The committee has decided that the contents of this publication will remain unchanged until the maintenance result date indicated on the IEC web site under "http://webstore.iec.ch" in the data related to the specific publication. At this date, the publication will be

- reconfirmed,
- withdrawn,
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INTRODUCTION

Electronic systems based on 1U chassis design have become one of the most important platforms used for servers, industrial electronics, information technology (IT) and telecommunication equipment. 1U chassis are sometimes referred to as "Pizza Boxes".

Applications for 1U chassis designs are wide spread and solutions are found in every segment of the electronics industry.

IEC 60297-3-100 defines the dimensional rack/cabinet details such as the available aperture and the front panel mounting dimensions. However, IEC 60297-3-100 falls short of providing guidance or dimensional requirements for assembling 1U chassis designs into these IEC 60297 conforming racks/cabinets either in singles or in multiples (stacked in $n \times 1$ U).

This part of IEC 60297 will give guidance and provide for dimensional requirements for 1U chassis based on weight loading, physical size and service accessibility.

In this standard, various chassis types are identified according to application needs.

The defined interface dimensions of the various chassis types permit the development of common mounting accessories. Due to this clarification and the application specific chassis type choice, the serviceability and airflow aspects of the chosen 1U chassis can be addressed by the designer.

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Similar attributes for multiple unit high equipment may be derived from this standard. The economical value of this standard lies in the predefined interface dimensions of chassis for which suitable accessories may be developed. In addition, as a consequence of the chosen mounting support, the cooling possibilities are indicated.

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MECHANICAL STRUCTURES FOR ELECTRONIC EQUIPMENT – DIMENSIONS OF MECHANICAL STRUCTURES OF THE 482,6 mm (19 in) SERIES –

Part 3-105: Dimensions and design aspects for 1U high chassis

1 Scope

This part of IEC 60297 specifies the dimensions for 1U chassis mounted into IEC 60297-3-100 compliant racks/cabinets where dimensions, loaded weight and accessibility require differing assembly methods.

Guidance for cooling and reference for EMC, seismic and for the climatic and mechanical requirements and tests are provided, as defined in the IEC 61587 series.

The drawings used in this standard are not intended to indicate product design, only the specific dimensions shall be used.

The terminology used complies with IEC 60917-1.

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2 Normative references (standards.iteh.ai)

The following referenced documents are indispensable for the application of this document. For dated references, only the edition of the references, the latest edition of the referenced document (including any amendments) applies: 4e52-990f-81fc3b34cec3/iec-60297-3-105-2008

IEC 60050-581, International electrotechnical vocabulary – Part 581: Electromechanical components for electronic equipment

IEC 60917-1, Modular order for the development of mechanical structures for electronic equipment practices – Part 1: Generic standard

IEC 60297-3-100, Mechanical structures for electronic equipment – Dimensions of mechanical structures of the 482,6 mm (19 in) series – Part 3-100: Basic dimensions of front panels, subracks, chassis, racks and cabinets

IEC 61587-1, Mechanical structures for electronic equipment — Tests for IEC 60917 and IEC 60297 — Part 1: Climatic, mechanical tests and safety aspects for cabinets, racks, subracks and chassis

IEC 61587-2, Mechanical structures for electronic equipment — Tests for IEC 60917 and IEC 60297 — Part 2: Seismic tests for cabinets and racks

IEC 61587-3, Mechanical structures for electronic equipment – Tests for IEC 60917 and IEC 60297 – Part 3: Electromagnetic shielding performance tests for cabinets, racks and subracks

3 Terms and definitions

For the purposes of this document, the terms and definitions of IEC 60917-1 and IEC 60050-581 apply, as well as the following.

3.1

19 in cabinet

cabinet in accordance with IEC 60297-3-100

3.2

19 in vertical members

parts of a cabinet with the mounting holes for front panels, chassis and subracks

3.3

chassis slides

angled parts mounted in the cabinet to support heavy or deep chassis (see also IEC 60917-1)

3.4

telescopic slide

extendable mounting support for heavy or deep chassis within a cabinet, providing easy access to rear parts in extended position of the chassis

3.5

aperture of a cabinet

horizontal opening dimension between two 19 in uprights

3.6

height pitch line

theoretical line between any increment of U (1U = 44,45 mm) VIEW

3.7

(standards.iteh.ai)

cable management

cable routing within a cabinet to the equipment

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chassis mounting flanges

may be an integrated part of the chassis or separate brackets attached to the chassis

3.9

cable pull factor

summary of cable weight, linked to the chassis

4 Arrangement overview

The arrangement overview in Figure 1 illustrates the chassis mounting methods into a typical 19 in cabinet.

The 1U chassis dimensions differ pending on the choice of the chassis type and resulting mounting dimensions. There are three types of chassis, determined by the principal methods of mounting into a cabinet. The definitions of the three types of chassis are:

- Chassis type A: This type of chassis is mounted into racks/cabinets without chassis supports (light weight, shallow equipment with low cable pull factor, IEC 61587-1 DL 1 shock/vibration environment). For the assembly into cabinets only, the chassis mounting flanges are bolted to the 19 in uprights. This type of chassis provides the maximum use of the available width and heights within a 1U section. See Figure 1.
- Chassis type B: This type of chassis is designated for equipment with higher load (high rear cabling pull factor, IEC 61587-1 DL 1 shock/vibration environment). Therefore, chassis slides shall be used. The chassis design shall provide recessed areas as a space for the cabinet mounted chassis slides. See Figure 2.

• Chassis type C: This type of chassis is designated for extendable equipment mounted on telescopic slides (top cover and/or rear I/O access via rear cable management, IEC 61587-1 DL 1 environment). Telescopic slides may be of two or three parts, dependent on the extension requirement. The chassis design shall provide on both sides recessed areas dependent on the required space for the telescopic slides.

NOTE There is no standard for telescopic slides, mounting dimensions should be defined by the equipment design. See Figure 3.

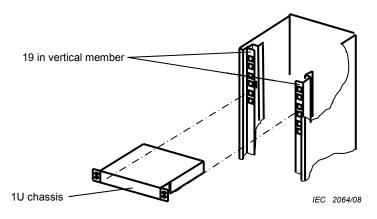


Figure 1 - Chassis type A

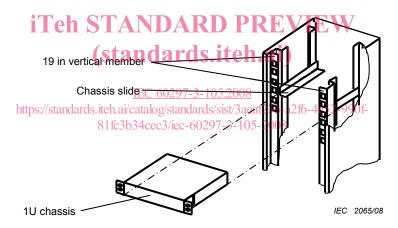


Figure 2 - Chassis type B

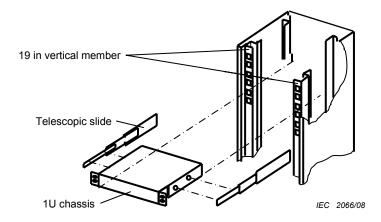


Figure 3 - Chassis type C

5 Dimensions of the 1U chassis

IEC 60297-3-100 defines the front panel dimensions and the aperture of the rack/cabinet.

5.1 Chassis type A

This type of chassis is typically of either light weight, limited depth and/or has a very low cable pull factor. Therefore, the centre of gravity is relatively close to the chassis front panel where the chassis mounting screws to the rack/cabinet uprights are located. Figure 4 illustrates the recommended chassis dimensions utilizing the maximum available cabinet aperture dimension for a 1U chassis. The maximum cable pull factor is to be considered in addition to the maximum weight. The mounted chassis vertical deflection shall not pass over the theoretical rack/cabinet height pitch line.

The maximum width as shown in Figure 4 includes any attached mounting flanges as well as mounting screws.

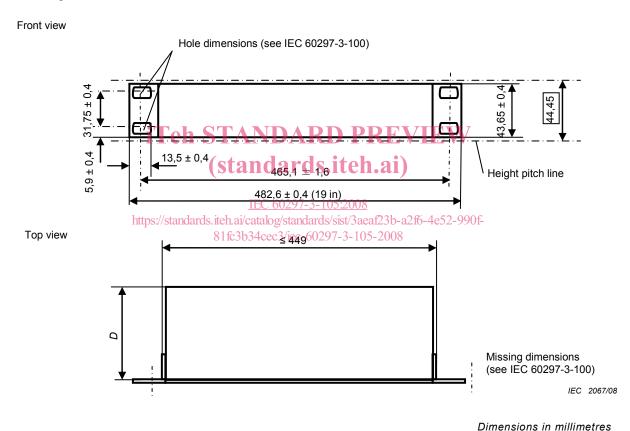


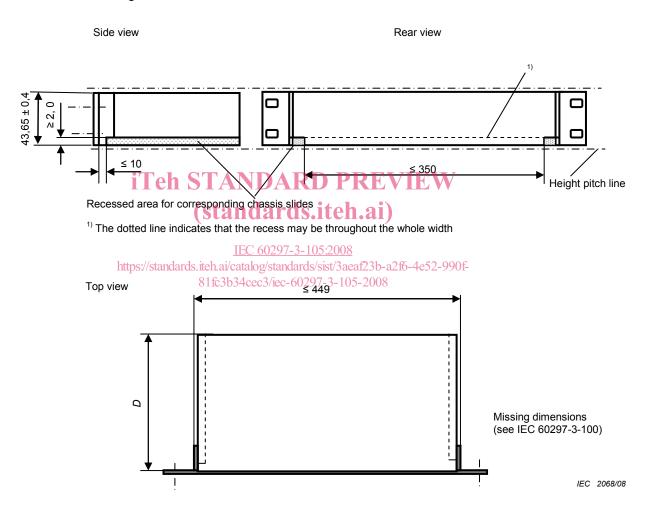
Figure 4 - Dimensions of chassis type A

5.2 Chassis type B

For the type B chassis as shown in Figure 5 the chassis height dimension shall be reduced in order to provide for chassis support space. For the purposes of this standard, the chassis height is reduced by 2 mm at the bottom of the chassis height. This provides for an interference free modular mounting approach of multiple and/or different chassis or subracks in a rack/cabinet.

Where maximum available chassis height is required, only the chassis to mounting support interfaces have to be observed.

For safety reasons and for the load bearing calculation of the chassis slides, the total weight shall not exceed 25 kg.



Dimensions in millimetres

Figure 5 – Dimensions of chassis type B